# **Data Sheet**

# **TABLE OF CONTENTS**

| Features  |
|---|
| Applications  |
| General Description   |
| Functional Block Diagrams   |
| Revision History  |
| Specifications  |
| Electrical Characteristics—5 V Operation3                         |
| Electrical Characteristics—3.3 V Operation4                       |
| Electrical Characteristics—2.5 V Operation                        |
| Electrical Characteristics—1.8 V Operation7                       |
| Insulation and Safety Related Specifications9                     |
| Package Characteristics   |
| Regulatory Information10  |
| Regulatory information10  |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation                    |
|   |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation                    |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation<br>Characteristics |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics    |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics    |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics    |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics    |
| DIN V VDE V 0884-10 (VDE V 0884-10) Insulation Characteristics    |

| Absolute Maximum Ratings                     | 13 |
|--|----|
| ESD Caution                                  | 13 |
| Pin Configurations and Function Descriptions | 15 |
| Typical Performance Characteristics          | 18 |
| Theory of Operation                          | 19 |
| Overview                                     | 19 |
| Applications Information                     | 20 |
| PCB Layout                                   | 20 |
| Propagation Delay Related Parameters         | 20 |
| Jitter Measurement                           | 20 |
| Insulation Lifetime                          | 20 |
| Outline Dimensions                           | 22 |
| Ordering Guide                               | 23 |
| Automotive Products                          | 23 |

## 4/2016—Revision 0: Initial Version

# **SPECIFICATIONS**

## **ELECTRICAL CHARACTERISTICS—5 V OPERATION**

All typical specifications are at  $T_A = 25^{\circ}\text{C}$ ,  $V_{DD1} = V_{DD2} = 5$  V. Minimum/maximum specifications apply over the entire recommended operation range of 4.5 V  $\leq$   $V_{DD1} \leq$  5.5 V, 4.5 V  $\leq$   $V_{DD2} \leq$  5.5 V, and  $-40^{\circ}\text{C} \leq$   $T_A \leq +125^{\circ}\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15$  pF and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 1.

| Parameter                    | Symbol                              | Min                  | Тур                    | Max                  | Unit    | Test Conditions/Comments   |
|------------------------------|-------------------------------------|----------------------|------------------------|----------------------|---------|--|
| SWITCHING SPECIFICATIONS     |                                     |                      |                        |                      |         |  |
| Pulse Width                  | PW                                  | 6.6                  |                        |                      | ns      | Within pulse width distortion (PWD) limit                        |
| Data Rate                    |                                     | 150                  |                        |                      | Mbps    | Within PWD limit   |
| Propagation Delay            | t <sub>PHL</sub> , t <sub>PLH</sub> | 4.8                  | 7.2                    | 13                   | ns      | 50% input to 50% output  |
| Pulse Width Distortion       | PWD                                 |                      | 0.5                    | 3                    | ns      | tplh - tphl  |
| Change vs. Temperature       |                                     |                      | 1.5                    |                      | ps/°C   |  |
| Propagation Delay Skew       | <b>t</b> <sub>PSK</sub>             |                      |                        | 6.0                  | ns      | Between any two units at the same temperature, voltage, and load |
| Channel Matching             |                                     |                      |                        |                      |         |  |
| Codirectional                | t <sub>PSKCD</sub>                  |                      | 0.5                    | 3.0                  | ns      |  |
| Opposing Direction           | <b>t</b> <sub>PSKOD</sub>           |                      | 0.5                    | 3.0                  | ns      |  |
| Jitter                       |                                     |                      | 380                    |                      | ps p-p  | See the Jitter Measurement section                               |
|                              |                                     |                      | 55                     |                      | ps rms  | See the Jitter Measurement section                               |
| DC SPECIFICATIONS            |                                     |                      |                        |                      |         |  |
| Input Threshold              |                                     |                      |                        |                      |         |  |
| Logic High                   | V <sub>IH</sub>                     | $0.7 \times V_{DDx}$ |                        |                      | V       |  |
| Logic Low                    | VIL                                 |                      |                        | $0.3 \times V_{DDx}$ | V       |  |
| Output Voltage               |                                     |                      |                        |                      |         |  |
| Logic High                   | V <sub>OH</sub>                     | $V_{DDx} - 0.1$      | $V_{DDx}$              |                      | V       | $I_{Ox}^{1} = -20 \mu A, V_{Ix} = V_{IxH}^{2}$                   |
|                              |                                     | $V_{DDx} - 0.4$      | $V_{\text{DDx}} - 0.2$ |                      | V       | $I_{Ox}^{1} = -4 \text{ mA}, V_{Ix} = V_{IxH}^{2}$               |
| Logic Low                    | V <sub>OL</sub>                     |                      | 0.0                    | 0.1                  | V       | $I_{Ox}^1 = 20 \mu A, V_{Ix} = V_{IxL}^3$                        |
|                              |                                     |                      | 0.2                    | 0.4                  | V       | $I_{Ox}^{1} = 4 \text{ mA}, V_{Ix} = V_{IxL}^{3}$                |
| Input Current per Channel    | l <sub>l</sub>                      | -10                  | +0.01                  | +10                  | μΑ      | $0 \text{ V} \leq V_{lx} \leq V_{DDx}$                           |
| Quiescent Supply Current     |                                     |                      |                        |                      |         |  |
| ADuM220N/ADuM225N            |                                     |                      |                        |                      |         |  |
|                              | I <sub>DD1 (Q)</sub>                |                      | 0.9                    | 1.3                  | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>                            |
|                              | I <sub>DD2 (Q)</sub>                |                      | 1.3                    | 1.8                  | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>                            |
|                              | I <sub>DD1 (Q)</sub>                |                      | 6.4                    | 10.0                 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$                               |
|                              | I <sub>DD2 (Q)</sub>                |                      | 1.4                    | 1.9                  | mA      | $V_1^4 = 1$ (N0), 0 (N1) <sup>5</sup>                            |
| ADuM221N/ADuM226N            |                                     |                      |                        |                      |         |  |
|                              | I <sub>DD1 (Q)</sub>                |                      | 1.1                    | 1.6                  | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>                            |
|                              | I <sub>DD2 (Q)</sub>                |                      | 1.1                    | 1.5                  | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>                            |
|                              | I <sub>DD1 (Q)</sub>                |                      | 4.0                    | 5.8                  | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$                               |
|                              | I <sub>DD2 (Q)</sub>                |                      | 4.9                    | 6.4                  | mA      | $V_1^4 = 1$ (N0), 0 (N1) <sup>5</sup>                            |
| Dynamic Supply Current       |                                     |                      |                        |                      |         |  |
| Dynamic Input                | I <sub>DDI (D)</sub>                |                      | 0.01                   |                      | mA/Mbps | Inputs switching, 50% duty cycle                                 |
| Dynamic Output               | I <sub>DDO (D)</sub>                |                      | 0.02                   |                      | mA/Mbps | Inputs switching, 50% duty cycle                                 |
| Undervoltage Lockout         | UVLO                                |                      |                        |                      |         |  |
| Positive $V_{DDx}$ Threshold | $V_{DDxUV+}$                        |                      | 1.6                    |                      | V       |  |
| $NegativeV_{DDx}Threshold$   | $V_{DDxUV-}$                        |                      | 1.5                    |                      | V       |  |
| V <sub>DDx</sub> Hysteresis  | $V_{DDxUVH}$                        |                      | 0.1                    |                      | V       |  |

| Parameter                                      | Symbol                         | Min | Тур | Max | Unit  | Test Conditions/Comments  |
|--|--------------------------------|-----|-----|-----|-------|---|
| AC SPECIFICATIONS                              |                                |     |     |     |       |   |
| Output Rise/Fall Time                          | t <sub>R</sub> /t <sub>F</sub> |     | 2.5 |     | ns    | 10% to 90%  |
| Common-Mode Transient<br>Immunity <sup>6</sup> | CM <sub>H</sub>                | 75  | 100 |     | kV/μs | $V_{lx} = V_{DDx}$ , $V_{CM} = 1000 \text{ V}$ ,<br>transient magnitude = 800 V |
|  | CM <sub>L</sub>                | 75  | 100 |     | kV/μs | $V_{lx} = 0 \text{ V}, V_{CM} = 1000 \text{ V},$<br>transient magnitude = 800 V |

<sup>&</sup>lt;sup>1</sup> I<sub>Ox</sub> is the Channel x output current, where x is A or B.

Table 2. Total Supply Current vs. Data Throughput

|                       |                  | 1 Mbps |     | 25 Mbps |     |     | 100 Mbps |     |     |     |      |
|-----------------------|------------------|--------|-----|---------|-----|-----|----------|-----|-----|-----|------|
| Parameter             | Symbol           | Min    | Тур | Max     | Min | Тур | Max      | Min | Тур | Max | Unit |
| SUPPLY CURRENT        |                  |        |     |         |     |     |          |     |     |     |      |
| ADuM220N/ADuM225N     |                  |        |     |         |     |     |          |     |     |     |      |
| Supply Current Side 1 | I <sub>DD1</sub> |        | 3.7 | 6.8     |     | 4.2 | 7.2      |     | 6.2 | 9.3 | mA   |
| Supply Current Side 2 | I <sub>DD2</sub> |        | 1.4 | 2.0     |     | 2.2 | 3.2      |     | 4.8 | 8.1 | mA   |
| ADuM221N/ADuM226N     |                  |        |     |         |     |     |          |     |     |     |      |
| Supply Current Side 1 | I <sub>DD1</sub> |        | 2.6 | 4.5     |     | 3.2 | 5.4      |     | 5.4 | 8.2 | mA   |
| Supply Current Side 2 | I <sub>DD2</sub> |        | 3.0 | 4.9     |     | 3.7 | 5.9      |     | 5.9 | 8.6 | mA   |

## **ELECTRICAL CHARACTERISTICS—3.3 V OPERATION**

All typical specifications are at  $T_A = 25^{\circ}\text{C}$ ,  $V_{DD1} = V_{DD2} = 3.3 \text{ V}$ . Minimum/maximum specifications apply over the entire recommended operation range:  $3.0 \text{ V} \le V_{DD1} \le 3.6 \text{ V}$ ,  $3.0 \text{ V} \le V_{DD2} \le 3.6 \text{ V}$ , and  $-40^{\circ}\text{C} \le T_A \le +125^{\circ}\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15 \text{ pF}$  and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 3.

| Parameter                | Symbol                              | Min                  | Тур | Max                  | Unit   | Test Conditions/Comments   |
|--------------------------|-------------------------------------|----------------------|-----|----------------------|--------|--|
| SWITCHING SPECIFICATIONS |                                     |                      |     |                      |        |  |
| Pulse Width              | PW                                  | 6.6                  |     |                      | ns     | Within PWD limit   |
| Data Rate                |                                     | 150                  |     |                      | Mbps   | Within PWD limit   |
| Propagation Delay        | t <sub>PHL</sub> , t <sub>PLH</sub> | 4.8                  | 6.8 | 14                   | ns     | 50% input to 50% output  |
| Pulse Width Distortion   | PWD                                 |                      | 0.7 | 3                    | ns     | t <sub>PLH</sub> - t <sub>PHL</sub>                              |
| Change vs. Temperature   |                                     |                      | 1.5 |                      | ps/°C  |  |
| Propagation Delay Skew   | <b>t</b> <sub>PSK</sub>             |                      |     | 7.0                  | ns     | Between any two units at the same temperature, voltage, and load |
| Channel Matching         |                                     |                      |     |                      |        |  |
| Codirectional            | <b>t</b> <sub>PSKCD</sub>           |                      | 0.7 | 3.0                  | ns     |  |
| Opposing Direction       | <b>t</b> <sub>PSKOD</sub>           |                      | 0.7 | 3.0                  | ns     |  |
| Jitter                   |                                     |                      | 290 |                      | ps p-p | See the Jitter Measurement section                               |
|                          |                                     |                      | 45  |                      | ps rms | See the Jitter Measurement section                               |
| DC SPECIFICATIONS        |                                     |                      |     |                      |        |  |
| Input Threshold          |                                     |                      |     |                      |        |  |
| Logic High               | V <sub>IH</sub>                     | $0.7 \times V_{DDx}$ |     |                      | V      |  |
| Logic Low                | VIL                                 |                      |     | $0.3 \times V_{DDx}$ | V      |  |

 $<sup>^{2}</sup>$   $V_{lxH}$  is the input side logic high.

 $<sup>^3\,</sup>V_{lxL}$  is the input side logic low.

<sup>&</sup>lt;sup>4</sup> V₁ is the voltage input.

<sup>&</sup>lt;sup>5</sup> NO refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the Ordering Guide section.

 $<sup>^6</sup>$   $|CM_H|$  is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output  $(V_0) > 0.8 \text{ V}_{DDs}$ .  $|CM_L|$  is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \text{ V}$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

| Parameter                                      | Symbol                         | Min                    | Тур                    | Max | Unit    | Test Conditions/Comments  |
|--|--------------------------------|------------------------|------------------------|-----|---------|---|
| Output Voltage                                 |                                |                        | •                      |     |         |   |
| Logic High                                     | V <sub>OH</sub>                | V <sub>DDx</sub> - 0.1 | $V_{DDx}$              |     | V       | $I_{Ox}^{1} = -20 \mu A, V_{Ix} = V_{IxH}^{2}$  |
|  |                                | $V_{DDx} - 0.4$        | $V_{\text{DDx}} - 0.2$ |     | V       | $I_{Ox}^1 = -2 \text{ mA}, V_{Ix} = V_{IxH}^2$  |
| Logic Low                                      | Vol                            |                        | 0.0                    | 0.1 | V       | $I_{Ox}^1 = 20 \mu A, V_{Ix} = V_{IxL}^3$   |
|  |                                |                        | 0.2                    | 0.4 | V       | $I_{Ox}^1 = 2 \text{ mA}, V_{Ix} = V_{IxL}^3$   |
| Input Current per Channel                      | l <sub>i</sub>                 | -10                    | +0.01                  | +10 | μΑ      | $0 \text{ V} \leq V_{lx} \leq V_{DDx}$  |
| Quiescent Supply Current<br>ADuM220N/ADuM225N  |                                |                        |                        |     |         |   |
|  | I <sub>DD1</sub> (Q)           |                        | 0.8                    | 1.3 | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>   |
|  | I <sub>DD2</sub> (Q)           |                        | 1.2                    | 1.8 | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>   |
|  | I <sub>DD1</sub> (Q)           |                        | 6.3                    | 9.7 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$  |
|  | I <sub>DD2</sub> (Q)           |                        | 1.3                    | 1.8 | mA      | $V_1^4 = 1$ (N0), 0 (N1) <sup>5</sup>   |
| ADuM221N/ADuM226N                              |                                |                        |                        |     |         |   |
|  | I <sub>DD1</sub> (Q)           |                        | 1.0                    | 1.6 | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>   |
|  | I <sub>DD2 (Q)</sub>           |                        | 1.0                    | 1.5 | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$   |
|  | I <sub>DD1 (Q)</sub>           |                        | 3.9                    | 5.8 | mA      | $V_1^4 = 1$ (N0), 0 (N1) <sup>5</sup>   |
|  | I <sub>DD2 (Q)</sub>           |                        | 4.8                    | 6.4 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$  |
| Dynamic Supply Current                         |                                |                        |                        |     |         | Inputs switching, 50% duty cycle  |
| Dynamic Input                                  | I <sub>DDI (D)</sub>           |                        | 0.01                   |     | mA/Mbps |   |
| Dynamic Output                                 | I <sub>DDO (D)</sub>           |                        | 0.01                   |     | mA/Mbps |   |
| Undervoltage Lockout                           | UVLO                           |                        |                        |     |         |   |
| Positive V <sub>DDx</sub> Threshold            | $V_{DDxUV+}$                   |                        | 1.6                    |     | V       |   |
| Negative $V_{DDx}$ Threshold                   | $V_{DDxUV-}$                   |                        | 1.5                    |     | V       |   |
| V <sub>DDx</sub> Hysteresis                    | $V_{DDxUVH}$                   |                        | 0.1                    |     | V       |   |
| AC SPECIFICATIONS                              |                                |                        |                        |     |         |   |
| Output Rise/Fall Time                          | t <sub>R</sub> /t <sub>F</sub> |                        | 2.5                    |     | ns      | 10% to 90%  |
| Common-Mode Transient<br>Immunity <sup>6</sup> | CM <sub>H</sub>                | 75                     | 100                    |     | kV/μs   | $V_{Ix} = V_{DDx}$ , $V_{CM} = 1000 \text{ V}$ , transient magnitude = $800 \text{ V}$  |
|  | CM <sub>L</sub>                | 75                     | 100                    |     | kV/μs   | $V_{Ix} = 0 \text{ V}, V_{CM} = 1000 \text{ V}, \text{ transient}$<br>magnitude = 800 V |

 $<sup>^{\</sup>scriptscriptstyle 1}\,I_{\rm 0x}$  is the Channel x output current, where x is A or B.

Table 4. Total Supply Current vs. Data Throughput

|                       |                  |     | 1 Mbps 25 Mbps |     | os  |     |     |     |     |     |      |
|-----------------------|------------------|-----|----------------|-----|-----|-----|-----|-----|-----|-----|------|
| Parameter             | Symbol           | Min | Тур            | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| SUPPLY CURRENT        |                  |     |                |     |     |     |     |     |     |     |      |
| ADuM220N/ADuM225N     |                  |     |                |     |     |     |     |     |     |     |      |
| Supply Current Side 1 | I <sub>DD1</sub> |     | 3.6            | 6.2 |     | 4.0 | 6.7 |     | 5.6 | 9.1 | mA   |
| Supply Current Side 2 | I <sub>DD2</sub> |     | 1.3            | 1.9 |     | 2.1 | 3.1 |     | 4.4 | 6.8 | mA   |
| ADuM221N/ADuM226N     |                  |     |                |     |     |     |     |     |     |     |      |
| Supply Current Side 1 | I <sub>DD1</sub> |     | 2.5            | 4.6 |     | 3.0 | 5.5 |     | 5.0 | 8.1 | mA   |
| Supply Current Side 2 | I <sub>DD2</sub> |     | 2.9            | 4.8 |     | 3.5 | 5.8 |     | 5.4 | 8.3 | mA   |

 $<sup>^{2}</sup>$   $V_{IxH}$  is the input side logic high.

<sup>&</sup>lt;sup>3</sup> V<sub>IxL</sub> is the input side logic low.

<sup>&</sup>lt;sup>4</sup> V<sub>1</sub> is the voltage input.

<sup>&</sup>lt;sup>5</sup> NO refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the Ordering Guide section.

 $<sup>^6</sup>$  [CM<sub>H</sub>] is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \, V_{DDx}$ . [CM<sub>L</sub>] is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \, V$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

## **ELECTRICAL CHARACTERISTICS—2.5 V OPERATION**

All typical specifications are at  $T_A = 25^{\circ}\text{C}$ ,  $V_{DD1} = V_{DD2} = 2.5 \text{ V}$ . Minimum/maximum specifications apply over the entire recommended operation range:  $2.25 \text{ V} \le V_{DD1} \le 2.75 \text{ V}$ ,  $2.25 \text{ V} \le V_{DD2} \le 2.75 \text{ V}$ ,  $-40^{\circ}\text{C} \le T_A \le +125^{\circ}\text{C}$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15 \text{ pF}$  and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 5.

| Parameter                           | Symbol                              | Min                    | Тур                    | Max                  | Unit    | Test Conditions/Comments   |
|-------------------------------------|-------------------------------------|------------------------|------------------------|----------------------|---------|--|
| SWITCHING SPECIFICATIONS            |                                     |                        |                        |                      |         |  |
| Pulse Width                         | PW                                  | 6.6                    |                        |                      | ns      | Within PWD limit   |
| Data Rate                           |                                     | 150                    |                        |                      | Mbps    | Within PWD limit   |
| Propagation Delay                   | t <sub>PHL</sub> , t <sub>PLH</sub> | 5.0                    | 7.0                    | 14                   | ns      | 50% input to 50% output  |
| Pulse Width Distortion              | PWD                                 |                        | 0.7                    | 3                    | ns      | t <sub>PLH</sub> - t <sub>PHL</sub>                              |
| Change vs. Temperature              |                                     |                        | 1.5                    |                      | ps/°C   | ·  |
| Propagation Delay Skew              | <b>t</b> <sub>PSK</sub>             |                        |                        | 7.0                  | ns      | Between any two units at the same temperature, voltage, and load |
| Channel Matching                    |                                     |                        |                        |                      |         |  |
| Codirectional                       | <b>t</b> <sub>PSKCD</sub>           |                        | 0.7                    | 3.0                  | ns      |  |
| Opposing Direction                  | t <sub>PSKOD</sub>                  |                        | 0.7                    | 3.0                  | ns      |  |
| Jitter                              |                                     |                        | 320                    |                      | ps p-p  | See the Jitter Measurement section                               |
|                                     |                                     |                        | 65                     |                      | ps rms  | See the Jitter Measurement section                               |
| DC SPECIFICATIONS                   |                                     |                        |                        |                      |         |  |
| Input Threshold                     |                                     |                        |                        |                      |         |  |
| Logic High                          | V <sub>IH</sub>                     | $0.7 \times V_{DDx}$   |                        |                      | V       |  |
| Logic Low                           | VIL                                 |                        |                        | $0.3 \times V_{DDx}$ | V       |  |
| Output Voltage                      |                                     |                        |                        |                      |         |  |
| Logic High                          | Vон                                 | $V_{\text{DDx}} - 0.1$ | $V_{DDx}$              |                      | V       | $I_{Ox}^{1} = -20 \mu A, V_{Ix} = V_{IxH}^{2}$                   |
|                                     |                                     | $V_{DDx} - 0.4$        | $V_{\text{DDx}} - 0.2$ |                      | V       | $I_{Ox}^1 = -2 \text{ mA}, V_{Ix} = V_{IxH}^2$                   |
| Logic Low                           | Vol                                 |                        | 0.0                    | 0.1                  | V       | $I_{Ox}^{1} = 20 \mu A, V_{Ix} = V_{IxL}^{3}$                    |
|                                     |                                     |                        | 0.2                    | 0.4                  | V       | $I_{0x}^{1} = 2 \text{ mA, } V_{1x} = V_{1xL}^{3}$               |
| Input Current per Channel           | l <sub>i</sub>                      | -10                    | +0.01                  | +10                  | μΑ      | $0 \text{ V} \leq V_{lx} \leq V_{DDx}$                           |
| Quiescent Supply Current            |                                     |                        |                        |                      |         |  |
| ADuM220N/ADuM225N                   |                                     |                        |                        |                      |         |  |
|                                     | I <sub>DD1 (Q)</sub>                |                        | 0.8                    | 1.2                  | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                      |
|                                     | I <sub>DD2 (Q)</sub>                |                        | 1.2                    | 1.8                  | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                      |
|                                     | I <sub>DD1 (Q)</sub>                |                        | 6.2                    | 9.5                  | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$                               |
|                                     | I <sub>DD2 (Q)</sub>                |                        | 1.3                    | 1.8                  | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$                               |
| ADuM221N/ADuM226N                   |                                     |                        |                        |                      |         |  |
|                                     | I <sub>DD1 (Q)</sub>                |                        | 1.0                    | 1.5                  | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                      |
|                                     | I <sub>DD2 (Q)</sub>                |                        | 1.0                    | 1.4                  | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                      |
|                                     | I <sub>DD1 (Q)</sub>                |                        | 3.9                    | 5.8                  | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$                               |
|                                     | I <sub>DD2 (Q)</sub>                |                        | 4.8                    | 6.4                  | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$                               |
| Dynamic Supply Current              |                                     |                        |                        |                      |         | Inputs switching, 50% duty cycle                                 |
| Dynamic Input                       | I <sub>DDI (D)</sub>                |                        | 0.01                   |                      | mA/Mbps |  |
| Dynamic Output                      | I <sub>DDO (D)</sub>                |                        | 0.01                   |                      | mA/Mbps |  |
| Undervoltage Lockout                |                                     |                        |                        |                      |         |  |
| Positive V <sub>DDx</sub> Threshold | $V_{DDxUV+}$                        |                        | 1.6                    |                      | V       |  |
| Negative V <sub>DDx</sub> Threshold | $V_{DDxUV-}$                        |                        | 1.5                    |                      | V       |  |
| V <sub>DDx</sub> Hysteresis         | $V_{DDxUVH}$                        |                        | 0.1                    |                      | V       |  |

| Parameter                                      | Symbol                         | Min | Тур | Max | Unit  | Test Conditions/Comments   |
|--|--------------------------------|-----|-----|-----|-------|--|
| AC SPECIFICATIONS                              |                                |     |     |     |       |  |
| Output Rise/Fall Time                          | t <sub>R</sub> /t <sub>F</sub> |     | 2.5 |     | ns    | 10% to 90%   |
| Common-Mode Transient<br>Immunity <sup>6</sup> | CM <sub>H</sub>                | 75  | 100 |     | kV/μs | $V_{lx} = V_{DDx_r} V_{CM} = 1000 \text{ V}$ , transient magnitude = 800 V       |
|  | CM <sub>L</sub>                | 75  | 100 |     | kV/μs | $V_{lx} = 0 \text{ V}$ , $V_{CM} = 1000 \text{ V}$ , transient magnitude = 800 V |

<sup>&</sup>lt;sup>1</sup> I<sub>Ox</sub> is the Channel x output current, where x is A or B.

Table 6. Total Supply Current vs. Data Throughput

|                       |           |     | 1 Mbps |     |     | 25 Mbps |     |     | 100 Mbps |     |      |
|-----------------------|-----------|-----|--------|-----|-----|---------|-----|-----|----------|-----|------|
| Parameter             | Symbol    | Min | Тур    | Max | Min | Тур     | Max | Min | Тур      | Max | Unit |
| SUPPLY CURRENT        |           |     |        |     |     |         |     |     |          |     |      |
| ADuM220N/ADuM225N     |           |     |        |     |     |         |     |     |          |     |      |
| Supply Current Side 1 | $I_{DD1}$ |     | 3.5    | 6.2 |     | 3.9     | 6.6 |     | 5.4      | 9.0 | mA   |
| Supply Current Side 2 | $I_{DD2}$ |     | 1.3    | 1.9 |     | 1.9     | 2.8 |     | 3.6      | 5.8 | mA   |
| ADuM221N/ADuM226N     |           |     |        |     |     |         |     |     |          |     |      |
| Supply Current Side 1 | $I_{DD1}$ |     | 2.4    | 4.7 |     | 2.9     | 5.5 |     | 4.5      | 8.0 | mA   |
| Supply Current Side 2 | $I_{DD2}$ |     | 2.9    | 4.9 |     | 3.3     | 5.7 |     | 4.9      | 7.7 | mA   |

## **ELECTRICAL CHARACTERISTICS—1.8 V OPERATION**

All typical specifications are at  $T_A = 25^{\circ}C$ ,  $V_{DD1} = V_{DD2} = 1.8$  V. Minimum/maximum specifications apply over the entire recommended operation range:  $1.7 \text{ V} \leq V_{DD1} \leq 1.9 \text{ V}$ ,  $1.7 \text{ V} \leq V_{DD2} \leq 1.9 \text{ V}$ , and  $-40^{\circ}C \leq T_A \leq +125^{\circ}C$ , unless otherwise noted. Switching specifications are tested with  $C_L = 15$  pF and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 7.

| Parameter                 | Symbol                              | Min                  | Тур                    | Max                  | Unit   | Test Conditions/Comments   |
|---------------------------|-------------------------------------|----------------------|------------------------|----------------------|--------|--|
| SWITCHING SPECIFICATIONS  |                                     |                      |                        |                      |        |  |
| Pulse Width               | PW                                  | 6.6                  |                        |                      | ns     | Within PWD limit   |
| Data Rate                 |                                     | 150                  |                        |                      | Mbps   | Within PWD limit   |
| Propagation Delay         | t <sub>PHL</sub> , t <sub>PLH</sub> | 5.8                  | 8.7                    | 15                   | ns     | 50% input to 50% output  |
| Pulse Width Distortion    | PWD                                 |                      | 0.7                    | 3                    | ns     | t <sub>PLH</sub> - t <sub>PHL</sub>                              |
| Change vs. Temperature    |                                     |                      | 1.5                    |                      | ps/°C  |  |
| Propagation Delay Skew    | <b>t</b> <sub>PSK</sub>             |                      |                        | 7.0                  | ns     | Between any two units at the same temperature, voltage, and load |
| Channel Matching          |                                     |                      |                        |                      |        |  |
| Codirectional             | t <sub>PSKCD</sub>                  |                      | 0.7                    | 3.0                  | ns     |  |
| Opposing Direction        | <b>t</b> <sub>PSKOD</sub>           |                      | 0.7                    | 3.0                  | ns     |  |
| Jitter                    |                                     |                      | 630                    |                      | ps p-p | See the Jitter Measurement section                               |
|                           |                                     |                      | 190                    |                      | ps rms | See the Jitter Measurement section                               |
| DC SPECIFICATIONS         |                                     |                      |                        |                      |        |  |
| Input Threshold           |                                     |                      |                        |                      |        |  |
| Logic High                | V <sub>IH</sub>                     | $0.7 \times V_{DDx}$ |                        |                      | V      |  |
| Logic Low                 | VIL                                 |                      |                        | $0.3 \times V_{DDx}$ | V      |  |
| Output Voltage            |                                     |                      |                        |                      |        |  |
| Logic High                | V <sub>OH</sub>                     | $V_{DDx} - 0.1$      | $V_{DDx}$              |                      | V      | $I_{Ox}^{1} = -20 \mu A, V_{Ix} = V_{IxH}^{2}$                   |
|                           |                                     | $V_{DDx} - 0.4$      | $V_{\text{DDx}} - 0.2$ |                      | V      | $I_{Ox}^{1} = -2 \text{ mA}, V_{Ix} = V_{IxH}^{2}$               |
| Logic Low                 | V <sub>OL</sub>                     |                      | 0.0                    | 0.1                  | V      | $I_{Ox}^{1} = 20 \mu A, V_{Ix} = V_{IxL}^{3}$                    |
|                           |                                     |                      | 0.2                    | 0.4                  | V      | $I_{Ox}^{1} = 2 \text{ mA}, V_{Ix} = V_{IxL}^{3}$                |
| Input Current per Channel | I <sub>1</sub>                      | -10                  | +0.01                  | +10                  | μΑ     | $0 \text{ V} \leq V_{lx} \leq V_{DDx}$                           |

 $<sup>^{2}</sup>$   $V_{\text{IxH}}$  is the input side logic high.

 $<sup>^3\,</sup>V_{lxL}$  is the input side logic low.

<sup>&</sup>lt;sup>4</sup> V₁ is the voltage input.

<sup>&</sup>lt;sup>5</sup> NO refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the Ordering Guide section.

 $<sup>^6</sup>$  [CM<sub>H</sub>] is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \, V_{DDx}$ . [CM<sub>L</sub>] is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \, V$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

| Parameter                                      | Symbol                         | Min | Тур  | Max | Unit    | Test Conditions/Comments  |
|--|--------------------------------|-----|------|-----|---------|---|
| Quiescent Supply Current                       |                                |     |      |     |         |   |
| ADuM220N/ADuM225N                              |                                |     |      |     |         |   |
|  | I <sub>DD1 (Q)</sub>           |     | 0.7  | 1.2 | mA      | $V_1^4 = 0$ (N0), 1 (N1) <sup>5</sup>   |
|  | I <sub>DD2 (Q)</sub>           |     | 1.2  | 1.8 | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                                     |
|  | I <sub>DD1 (Q)</sub>           |     | 6.2  | 9.6 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$  |
|  | I <sub>DD2 (Q)</sub>           |     | 1.3  | 1.8 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$  |
| ADuM221N/ADuM226N                              |                                |     |      |     |         |   |
|  | I <sub>DD1 (Q)</sub>           |     | 1.0  | 1.5 | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                                     |
|  | I <sub>DD2 (Q)</sub>           |     | 1.0  | 1.4 | mA      | $V_1^4 = 0 \text{ (N0), } 1 \text{ (N1)}^5$                                     |
|  | I <sub>DD1 (Q)</sub>           |     | 3.8  | 5.8 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$  |
|  | I <sub>DD2 (Q)</sub>           |     | 4.7  | 6.4 | mA      | $V_1^4 = 1 \text{ (N0), 0 (N1)}^5$  |
| Dynamic Supply Current                         |                                |     |      |     |         | Inputs switching, 50% duty cycle  |
| Dynamic Input                                  | I <sub>DDI (D)</sub>           |     | 0.01 |     | mA/Mbps |   |
| Dynamic Output                                 | I <sub>DDO (D)</sub>           |     | 0.01 |     | mA/Mbps |   |
| Undervoltage Lockout                           | UVLO                           |     |      |     |         |   |
| Positive V <sub>DDx</sub> Threshold            | $V_{DDxUV+}$                   |     | 1.6  |     | V       |   |
| Negative V <sub>DDx</sub> Threshold            | $V_{DDxUV-}$                   |     | 1.5  |     | V       |   |
| V <sub>DDx</sub> Hysteresis                    | $V_{DDxUVH}$                   |     | 0.1  |     | V       |   |
| AC SPECIFICATIONS                              |                                |     |      |     |         |   |
| Output Rise/Fall Time                          | t <sub>R</sub> /t <sub>F</sub> |     | 2.5  |     | ns      | 10% to 90%  |
| Common-Mode Transient<br>Immunity <sup>6</sup> | CM <sub>H</sub>                | 75  | 100  |     | kV/μs   | $V_{lx} = V_{DDx}$ , $V_{CM} = 1000 \text{ V}$ ,<br>transient magnitude = 800 V |
|  | CM <sub>L</sub>                | 75  | 100  |     | kV/μs   | $V_{lx} = 0 \text{ V}, V_{CM} = 1000 \text{ V},$<br>transient magnitude = 800 V |

 $<sup>^{1}</sup>$   $I_{Ox}$  is the Channel x output current, where x is A or B.

Table 8. Total Supply Current vs. Data Throughput

| -                     |                  |     | 1 Mbp | s   |     | 25 Mbp | s   |     | 100 Mb | ps  |      |
|-----------------------|------------------|-----|-------|-----|-----|--------|-----|-----|--------|-----|------|
| Parameter             | Symbol           | Min | Тур   | Max | Min | Тур    | Max | Min | Тур    | Max | Unit |
| SUPPLY CURRENT        |                  |     |       |     |     |        |     |     |        |     |      |
| ADuM220N/ADuM225N     |                  |     |       |     |     |        |     |     |        |     |      |
| Supply Current Side 1 | I <sub>DD1</sub> |     | 3.4   | 6.0 |     | 3.8    | 6.4 |     | 5.2    | 8.4 | mA   |
| Supply Current Side 2 | $I_{DD2}$        |     | 1.2   | 1.8 |     | 1.8    | 2.8 |     | 3.6    | 5.8 | mA   |
| ADuM221N/ADuM226N     |                  |     |       |     |     |        |     |     |        |     |      |
| Supply Current Side 1 | I <sub>DD1</sub> |     | 2.4   | 4.7 |     | 2.8    | 5.5 |     | 4.4    | 7.8 | mA   |
| Supply Current Side 2 | I <sub>DD2</sub> |     | 2.8   | 4.8 |     | 3.2    | 5.6 |     | 4.8    | 7.9 | mA   |

 $<sup>^{2}</sup>$   $V_{\text{IxH}}$  is the input side logic high.

<sup>&</sup>lt;sup>3</sup> V<sub>lxL</sub> is the input side logic low.

<sup>&</sup>lt;sup>4</sup> V₁ is the voltage input.

<sup>&</sup>lt;sup>5</sup> NO refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the Ordering Guide section.

 $<sup>^6</sup>$  [CM<sub>H</sub>] is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \text{ V}_{DDs}$ . [CM<sub>L</sub>] is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \text{ V}$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

## **INSULATION AND SAFETY RELATED SPECIFICATIONS**

For additional information, see www.analog.com/icouplersafety.

Table 9. ADuM220N/ADuM221N

| Parameter   | Symbol  | Value | Unit   | Test Conditions/Comments   |
|---|---------|-------|--------|--|
| Rated Dielectric Insulation Voltage   |         | 5000  | V rms  | 1-minute duration  |
| Minimum External Air Gap (Clearance)  | L (I01) | 7.8   | mm min | Measured from input terminals to output terminals, shortest distance through air   |
| Minimum External Tracking (Creepage)  | L (102) | 7.8   | mm min | Measured from input terminals to output terminals, shortest distance path along body                                       |
| Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance) | L (PCB) | 8.3   | mm min | Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane |
| Minimum Internal Gap (Internal Clearance)                                   |         | 25.5  | μm min | Insulation distance through insulation   |
| Tracking Resistance (Comparative Tracking Index)                            | CTI     | >400  | V      | DIN IEC 112/VDE 0303 Part 1  |
| Material Group  |         | II    |        | Material Group (DIN VDE 0110, 1/89, Table 1)   |

## Table 10. ADuM225N/ADuM226N

| Parameter   | Symbol  | Value | Unit   | Test Conditions/Comments   |
|---|---------|-------|--------|--|
| Rated Dielectric Insulation Voltage   |         | 5000  | V rms  | 1-minute duration  |
| Minimum External Air Gap (Clearance)  | L (I01) | 8.3   | mm min | Measured from input terminals to output terminals, shortest distance through air   |
| Minimum External Tracking (Creepage)  | L (I02) | 8.3   | mm min | Measured from input terminals to output terminals, shortest distance path along body                                       |
| Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance) | L (PCB) | 8.3   | mm min | Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCE mounting plane |
| Minimum Internal Gap (Internal Clearance)                                   |         | 25.5  | μm min | Insulation distance through insulation   |
| Tracking Resistance (Comparative Tracking Index)                            | CTI     | >400  | ٧      | DIN IEC 112/VDE 0303 Part 1  |
| Material Group  |         | II    |        | Material Group (DIN VDE 0110, 1/89, Table 1)   |

### **PACKAGE CHARACTERISTICS**

Table 11. ADuM220N/ADuM221N

| Parameter                                    | Symbol           | Min Typ          | Max | Unit | Test Conditions/Comments                            |
|--|------------------|------------------|-----|------|---|
| Resistance (Input to Output) <sup>1</sup>    | R <sub>I-O</sub> | 10 <sup>13</sup> |     | Ω    |   |
| Capacitance (Input to Output)1               | C <sub>I-O</sub> | 2.2              |     | рF   | f = 1 MHz   |
| Input Capacitance <sup>2</sup>               | Cı               | 4.0              |     | рF   |   |
| IC Junction to Ambient Thermal<br>Resistance | θја              | 45               |     | °C/W | Thermocouple located at center of package underside |

<sup>&</sup>lt;sup>1</sup> These devices are considered 2-terminal devices: Pin 1 through Pin 8 are shorted together, and Pin 9 through Pin 16 are shorted together. <sup>2</sup> Input capacitance is from any input data pin to ground.

Table 12. ADuM225N/ADuM226N

| Parameter                                    | Symbol           | Min | Тур              | Max | Unit | Test Conditions/Comments                            |
|--|------------------|-----|------------------|-----|------|---|
| Resistance (Input to Output) <sup>1</sup>    | R <sub>I-O</sub> |     | 10 <sup>13</sup> |     | Ω    |   |
| Capacitance (Input to Output) <sup>1</sup>   | C <sub>I-O</sub> |     | 2.2              |     | рF   | f = 1 MHz   |
| Input Capacitance <sup>2</sup>               | Cı               |     | 4.0              |     | рF   |   |
| IC Junction to Ambient Thermal<br>Resistance | $\theta_{JA}$    |     | 80               |     | °C/W | Thermocouple located at center of package underside |

<sup>&</sup>lt;sup>1</sup> These devices are considered 2-terminal devices: Pin 1 through Pin 4 are shorted together, and Pin 5 through Pin 8 are shorted together.

<sup>&</sup>lt;sup>2</sup> Input capacitance is from any input data pin to ground.

#### **REGULATORY INFORMATION**

See Table 18 and Table 19 and the Insulation Lifetime section for details regarding recommended maximum working voltages for specific cross isolation waveforms and insulation levels.

The ADuM220N/ADuM221N are approved or pending approval by the organizations listed in Table 13.

Table 13.

| UL (Pending)  | CSA (Pending)   | VDE (Pending)  | CQC (Pending)                                   |
|---|---|--|---|
| Recognized Under UL 1577<br>Component Recognition<br>Program <sup>1</sup> | Approved under CSA Component<br>Acceptance Notice 5A  | DIN V VDE V 0884-10<br>(VDE V 0884-10):2006-12 <sup>2</sup>          | Certified by CQC11-471543-2015                  |
| Single Protection, 5000 V rms<br>Isolation Voltage                        | CSA 60950-1-07+A1+A2 and IEC 60950-1 second edition +A1+A2:                                       | Reinforced insulation, 849 V peak, V <sub>IOSM</sub> = 10,000 V peak | GB4943.1-2011                                   |
|   | Basic insulation at 780 V rms (1103 V peak)<br>Reinforced insulation at 390 V rms<br>(552 V peak) | Basic insulation 849 V peak,<br>V <sub>IOSM</sub> = 16,000 V peak    | Basic insulation at<br>780 V rms (1103 V peak)  |
| Double Protection,  | IEC 60601-1 Edition 3.1:  |  | Reinforced insulation at 389 V rms (552 V peak) |
| 5000 V rms Isolation<br>Voltage   | Basic insulation (1 means of patient protection (MOPP)), 490 V rms (686 V peak)                   |  |   |
|   | Reinforced insulation (2 MOPP), 238 V rms (325 V peak)  |  |   |
|   | CSA 61010-1-12 and IEC 61010-1 third edition:   |  |   |
|   | Basic insulation at 300 V rms mains, 780 V secondary (1103 V peak)                                |  |   |
|   | Reinforced insulation at: 300 V rms mains, 390 V secondary (552 V peak)                           |  |   |
| File E214100  | File 205078   | File 2471900-4880-0001   | File (CQC16001160971)                           |

 $<sup>^1</sup>$  In accordance with UL 1577, each ADuM220N/ADuM221N is proof tested by applying an insulation test voltage  $\geq$  6000 V rms for 1 sec.

The ADuM225N/ADuM226N are approved or pending approval by the organizations listed in Table 14.

Table 14.

| UL (Pending)  | CSA (Pending)  | VDE (Pending)  | CQC (Pending)                                     |
|---|--|--|---|
| UL 1577 Component<br>Recognition Program <sup>1</sup> | Approved under CSA Component Acceptance<br>Notice 5A   | DIN V VDE V 0884-10<br>(VDE V 0884-10):2006-12 <sup>2</sup>          | Certified by CQC11-471543-2012                    |
| Single Protection, 5000 V rms<br>Isolation Voltage    | CSA 60950-1-07+A1+A2 and IEC 60950-1 second edition +A1+A2:  | Reinforced insulation, 849 V peak, V <sub>IOSM</sub> = 10,000 V peak | GB4943.1-2011                                     |
|   | Basic insulation at 800 V rms (1131 V peak) Reinforced insulation at 400 V rms (565 V peak)  | Basic insulation 849 V peak,<br>V <sub>IOSM</sub> = 16,000 V peak    | Basic insulation at<br>800 V rms (1131 V peak)    |
| Double Protection,<br>5000 V rms Isolation<br>Voltage | IEC 60601-1 Edition 3.1:  Basic insulation (1 MOPP), 500 V rms (707 V peak)  Reinforced insulation (2 MOPP), 250 V rms (1414 V peak) |  | Reinforced insulation at<br>400 V rms (565 Vpeak) |
|   | CSA 61010-1-12 and IEC 61010-1 third edition:<br>Basic insulation at 300 V rms mains, 800 V<br>secondary (1089 V peak)               |  |   |
|   | Reinforced insulation at: 300 V rms mains, 400 V secondary (565 V peak)  |  |   |
| File E214100  | File 205078  | File 2471900-4880-0001   | File (pending)                                    |

 $<sup>^{1}</sup>$  In accordance with UL 1577, each ADuM225N/ADuM226N is proof tested by applying an insulation test voltage  $\geq$  6000 V rms for 1 sec.

<sup>&</sup>lt;sup>2</sup> In accordance with DIN V VDE V 0884-10, each ADuM220N/ADuM221N is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC). The \* marking branded on the component designates DIN V VDE V 0884-10 approval.

<sup>&</sup>lt;sup>2</sup> In accordance with DIN V VDE V 0884-10, each ADuM225N/ADuM226N is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC). The \* marking branded on the component designates DIN V VDE V 0884-10 approval.

## DIN V VDE V 0884-10 (VDE V 0884-10) INSULATION CHARACTERISTICS

These ADuM220N/ADuM221N/ADuM225N/ADuM226N isolators are suitable for reinforced electrical isolation only within the safety limit data. Protective circuits ensure the maintenance of the safety data. The \* marking on packages denotes DIN V VDE V 0884-10 approval.

Table 15.

| Description  | Test Conditions/Comments  | Symbol              | Characteristic | Unit   |
|--|---|---------------------|----------------|--------|
| Installation Classification per DIN VDE 0110             |   |                     |                |        |
| For Rated Mains Voltage ≤ 150 V rms                      |   |                     | I to IV        |        |
| For Rated Mains Voltage ≤ 300 V rms                      |   |                     | I to IV        |        |
| For Rated Mains Voltage ≤ 600 V rms                      |   |                     | I to IV        |        |
| Climatic Classification                                  |   |                     | 40/105/21      |        |
| Pollution Degree per DIN VDE 0110, Table 1               |   |                     | 2              |        |
| Maximum Working Insulation Voltage                       |   | V <sub>IORM</sub>   | 849            | V peak |
| Input to Output Test Voltage, Method B1                  | $V_{IORM} \times 1.875 = V_{pd (m)}$ , 100% production test,<br>$t_{ini} = t_m = 1$ sec, partial discharge < 5 pC | V <sub>pd (m)</sub> | 1592           | V peak |
| Input to Output Test Voltage, Method A                   |   |                     |                |        |
| After Environmental Tests Subgroup 1                     | $V_{IORM} \times 1.5 = V_{pd (m)}, t_{ini} = 60 \text{ sec, } t_m = 10 \text{ sec,}$<br>partial discharge < 5 pC  | V <sub>pd (m)</sub> | 1274           | V peak |
| After Input and/or Safety Test Subgroup 2 and Subgroup 3 | $V_{IORM} \times 1.2 = V_{pd (m)}$ , $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge $< 5$ pC               |                     | 1019           | V peak |
| Highest Allowable Overvoltage                            |   | V <sub>IOTM</sub>   | 7000           | V peak |
| Surge Isolation Voltage Basic                            | $V_{PEAK} = 16$ kV, 1.2 $\mu s$ rise time, 50 $\mu s$ , 50% fall time   | V <sub>IOSM</sub>   | 16,000         | V peak |
| Surge Isolation Voltage Reinforced                       | $V_{PEAK} = 16$ kV, 1.2 $\mu s$ rise time, 50 $\mu s$ , 50% fall time   | V <sub>IOSM</sub>   | 10,000         | V peak |
| Safety Limiting Values                                   | Maximum value allowed in the event of a failure (see Figure 5 or Figure 6)  |                     |                |        |
| Maximum Junction Temperature                             |   | Ts                  | 150            | °C     |
| Total Power Dissipation at 25°C                          |   | Ps                  |                |        |
| ADuM220N/ADuM221N  |   |                     | 2.78           | W      |
| ADuM225N/ADuM226N  |   |                     | 1.56           | W      |
| Insulation Resistance at Ts                              | $V_{10} = 500 \text{ V}$  | Rs                  | >109           | Ω      |

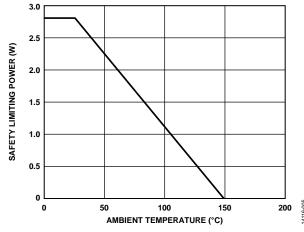


Figure 5. ADuM220N/ADuM221N Thermal Derating Curve, Dependence of Safety Limiting Values with Ambient Temperature per DIN V VDE V 0884-10

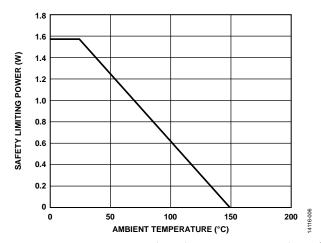


Figure 6. ADuM225N/ADuM226N Thermal Derating Curve, Dependence of Safety Limiting Values with Ambient Temperature per DIN V VDE V 0884-10

## **RECOMMENDED OPERATING CONDITIONS**

## Table 16.

| Parameter                        | Symbol                | Rating          |
|----------------------------------|-----------------------|-----------------|
| Operating Temperature            | T <sub>A</sub>        | -40°C to +125°C |
| Supply Voltages                  | $V_{DD1}$ , $V_{DD2}$ | 1.7 V to 5.5 V  |
| Input Signal Rise and Fall Times |                       | 1.0 ms          |

## ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

Table 17.

| Parameter  | Rating  |  |  |
|--|---|--|--|
| Storage Temperature (T <sub>ST</sub> ) Range             | −65°C to +150°C                               |  |  |
| Ambient Operating Temperature<br>(T <sub>A</sub> ) Range | −40°C to +125°C                               |  |  |
| Supply Voltages (V <sub>DD1</sub> , V <sub>DD2</sub> )   | −0.5 V to +7.0 V                              |  |  |
| Input Voltages (V <sub>IA</sub> , V <sub>IB</sub> )      | $-0.5 \text{ V to V}_{DDI}^1 + 0.5 \text{ V}$ |  |  |
| Output Voltages (V <sub>OA</sub> , V <sub>OB</sub> )     | $-0.5 \text{ V to V}_{DDO}^2 + 0.5 \text{ V}$ |  |  |
| Average Output Current per Pin <sup>3</sup>              |   |  |  |
| Side 1 Output Current (I <sub>01</sub> )                 | −10 mA to +10 mA                              |  |  |
| Side 2 Output Current (I <sub>02</sub> )                 | −10 mA to +10 mA                              |  |  |
| Common-Mode Transients <sup>4</sup>                      | –150 kV/μs to +150 kV/μs                      |  |  |

<sup>&</sup>lt;sup>1</sup> V<sub>DDI</sub> is the input side supply voltage.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Table 18. ADuM220N/ADuM221N Maximum Continuous Working Voltage<sup>1</sup>

| Parameter                | Rating      | Constraint   |
|--------------------------|-------------|--|
| AC Voltage               |             |  |
| Bipolar Waveform         |             |  |
| Basic Insulation         | 849 V peak  | 50-year minimum insulation lifetime  |
| Reinforced Insulation    | 767 V peak  | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-12 |
| <b>Unipolar Waveform</b> |             |  |
| Basic Insulation         | 1698 V peak | 50-year minimum insulation lifetime  |
| Reinforced Insulation    | 885 V peak  | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-12 |
| DC Voltage               |             | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-12 |
| Basic Insulation         | 1092 V peak |  |
| Reinforced Insulation    | 543 V peak  |  |

<sup>&</sup>lt;sup>1</sup> Maximum continuous working voltage refers to the continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

Table 19. ADuM225N/ADuM226N Maximum Continuous Working Voltage<sup>1</sup>

| Parameter             | Rating      | Constraint   |
|-----------------------|-------------|--|
| AC Voltage            |             |  |
| Bipolar Waveform      |             |  |
| Basic Insulation      | 849 V peak  | 50-year minimum insulation lifetime  |
| Reinforced Insulation | 789 V peak  | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-12 |
| Unipolar Waveform     |             | 50-year minimum insulation lifetime  |
| Basic Insulation      | 1698 V peak |  |
| Reinforced Insulation | 849 V peak  |  |
| DC Voltage            |             | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-12 |
| Basic Insulation      | 1118 V peak |  |
| Reinforced Insulation | 558 V peak  |  |

<sup>&</sup>lt;sup>1</sup> Maximum continuous working voltage refers to the continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

 $<sup>^2\,</sup>V_{\text{DDO}}$  is the output side supply voltage.

<sup>&</sup>lt;sup>3</sup> See Figure 5 or Figure 6 for the maximum rated current values for various temperatures.

<sup>&</sup>lt;sup>4</sup>This term refers to the common-mode transients across the insulation barrier. Common-mode transients exceeding the absolute maximum ratings may cause latch-up or permanent damage.

<sup>&</sup>lt;sup>2</sup> Insulation lifetime for the specified test condition is greater than 50 years.

<sup>&</sup>lt;sup>2</sup> Insulation lifetime for the specified test condition is greater than 50 years.

#### **Truth Table**

Table 20. ADuM220N/ADuM221N/ADuM225N/ADuM226N Truth Table (Positive Logic)

| V <sub>lx</sub> Input <sup>1, 2</sup> | V <sub>DDI</sub> State <sup>2</sup> | V <sub>DDO</sub> State <sup>2</sup> | Default Low (N0),<br>V <sub>Ox</sub> Output <sup>1, 2, 3</sup> | Default High (N1),<br>V <sub>Ox</sub> Output <sup>1, 2, 3</sup> | Test Conditions/<br>Comments |
|---------------------------------------|-------------------------------------|-------------------------------------|--|---|------------------------------|
|                                       |                                     |                                     | •  |   |                              |
| Low                                   | Powered                             | Powered                             | Low  | Low   | Normal operation             |
| High                                  | Powered                             | Powered                             | High   | High  | Normal operation             |
| X <sup>4</sup>                        | Unpowered                           | Powered                             | Low  | High  | Fail-safe output             |
| X <sup>4</sup>                        | Powered                             | Unpowered                           | Indeterminate  | Indeterminate   | Fail-safe output             |

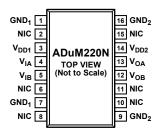
<sup>&</sup>lt;sup>1</sup> X means don't care.

<sup>&</sup>lt;sup>2</sup> V<sub>Ix</sub> and V<sub>Ox</sub> refer to the input and output signals of a given channel (A or B). V<sub>DDI</sub> and V<sub>DDO</sub> refer to the supply voltages on the input and output sides of the given channel, respectively.

<sup>&</sup>lt;sup>3</sup> NO refers to the ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models, and N1 refers to the ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1 models. See the Ordering Guide section.

<sup>&</sup>lt;sup>4</sup> Input pins  $(\vec{V}_{ix})$  on the same side as an unpowered supply must be in a low state to avoid powering the device through its ESD protection circuitry.

# PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



NOTES

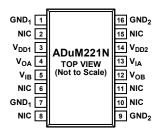
- 1. NIC = NO INTERNAL CONNECTION.
- 1. NIC = NO INTERNAL CONNECTION.
  2. PIN 1 AND PIN 7 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>1</sub> IS RECOMMENDED.
  3. PIN 9 AND PIN 16 ARE INTERNALLY CONNECTED, AND
- CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

Figure 7. ADuM220N Pin Configuration

Table 21. ADuM220N Pin Function Descriptions<sup>1</sup>

| Pin No. | Mnemonic         | Description  |  |  |  |  |
|---------|------------------|--|--|--|--|--|
| 1       | GND <sub>1</sub> | Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND <sub>1</sub> is recommended.  |  |  |  |  |
| 2       | NIC              | No Internal Connection. Leave this pin floating.   |  |  |  |  |
| 3       | $V_{DD1}$        | Supply Voltage for Isolator Side 1.  |  |  |  |  |
| 4       | V <sub>IA</sub>  | Logic Input A.   |  |  |  |  |
| 5       | V <sub>IB</sub>  | Logic Input B.   |  |  |  |  |
| 6       | NIC              | No Internal Connection. Leave this pin floating.   |  |  |  |  |
| 7       | GND₁             | Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to $GND_1$ is recommended.           |  |  |  |  |
| 8       | NIC              | No Internal Connection. Leave this pin floating.   |  |  |  |  |
| 9       | GND <sub>2</sub> | Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to $GND_2$ is recommended.          |  |  |  |  |
| 10      | NIC              | No Internal Connection. Leave this pin floating.   |  |  |  |  |
| 11      | NIC              | No Internal Connection. Leave this pin floating.   |  |  |  |  |
| 12      | V <sub>OB</sub>  | Logic Output B.  |  |  |  |  |
| 13      | V <sub>OA</sub>  | Logic Output A.  |  |  |  |  |
| 14      | $V_{DD2}$        | Supply Voltage for Isolator Side 2.  |  |  |  |  |
| 15      | NIC              | No Internal Connection. Leave this pin floating.   |  |  |  |  |
| 16      | GND₂             | Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to GND <sub>2</sub> is recommended. |  |  |  |  |

<sup>&</sup>lt;sup>1</sup> Reference the AN-1109 Application Note for specific layout guidelines.



- NOTES
  1. NIC = NO INTERNAL CONNECTION.
  2. PIN 1 AND PIN 7 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND, IS RECOMMENDED.
- 3. PIN 9 AND PIN 16 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

Figure 8. ADuM221N Pin Configuration

Table 22. ADuM221N Pin Function Descriptions<sup>1</sup>

| Pin No. | Mnemonic         | Description   |  |  |  |
|---------|------------------|---|--|--|--|
| 1       | GND <sub>1</sub> | Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND <sub>1</sub> is recommended. |  |  |  |
| 2       | NIC              | No Internal Connection. Leave this pin floating.  |  |  |  |
| 3       | $V_{DD1}$        | Supply Voltage for Isolator Side 1.   |  |  |  |
| 4       | V <sub>OA</sub>  | Logic Output A.   |  |  |  |
| 5       | V <sub>IB</sub>  | Logic Input B.  |  |  |  |
| 6       | NIC              | No Internal Connection. Leave this pin floating.  |  |  |  |
| 7       | GND₁             | Ground 1. Ground reference for Isolator Side 1. Pin 1 and Pin 7 are internally connected, and connecting both to GND <sub>1</sub> is recommended. |  |  |  |
| 8       | NIC              | No Internal Connection. Leave this pin floating.  |  |  |  |
| 9       | GND <sub>2</sub> | Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to $GND_2$ is recommended.         |  |  |  |
| 10      | NIC              | No Internal Connection. Leave this pin floating.  |  |  |  |
| 11      | NIC              | No Internal Connection. Leave this pin floating.  |  |  |  |
| 12      | V <sub>OB</sub>  | Logic Output B.   |  |  |  |
| 13      | V <sub>IA</sub>  | Logic Input A.  |  |  |  |
| 14      | $V_{DD2}$        | Supply Voltage for Isolator Side 2.   |  |  |  |
| 15      | NIC              | No Internal Connection. Leave this pin floating.  |  |  |  |
| 16      | GND <sub>2</sub> | Ground 2. Ground reference for Isolator Side 2. Pin 9 and Pin 16 are internally connected, and connecting both to $GND_2$ is recommended.         |  |  |  |

<sup>&</sup>lt;sup>1</sup> Reference the AN-1109 Application Note for specific layout guidelines.



Figure 9. ADuM225N Pin Configuration

Table 23. ADuM225N Pin Function Descriptions<sup>1</sup>

| Pin No. | Mnemonic         | Description                                     |  |  |  |
|---------|------------------|---|--|--|--|
| 1       | V <sub>DD1</sub> | Supply Voltage for Isolator Side 1.             |  |  |  |
| 2       | VIA              | Logic Input A.                                  |  |  |  |
| 3       | V <sub>IB</sub>  | Logic Input B.                                  |  |  |  |
| 4       | GND <sub>1</sub> | Ground 1. Ground reference for Isolator Side 1. |  |  |  |
| 5       | GND <sub>2</sub> | Ground 2. Ground reference for Isolator Side 2. |  |  |  |
| 6       | V <sub>OB</sub>  | Logic Output B.                                 |  |  |  |
| 7       | Voa              | Logic Output A.                                 |  |  |  |
| 8       | $V_{DD2}$        | Supply Voltage for Isolator Side 2.             |  |  |  |

<sup>&</sup>lt;sup>1</sup> Reference the AN-1109 Application Note for specific layout guidelines.

# **Data Sheet**

# ADuM220N/ADuM221N/ADuM225N/ADuM226N



Figure 10. ADuM226N Pin Configuration

Table 24. ADuM226N Pin Function Descriptions<sup>1</sup>

| Pin No. | Mnemonic         | Description                                     |
|---------|------------------|---|
| 1       | V <sub>DD1</sub> | Supply Voltage for Isolator Side 1.             |
| 2       | VOA              | Logic Output A.                                 |
| 3       | V <sub>IB</sub>  | Logic Input B.                                  |
| 4       | GND₁             | Ground 1. Ground reference for Isolator Side 1. |
| 5       | GND <sub>2</sub> | Ground 2. Ground reference for Isolator Side 2. |
| 6       | V <sub>OB</sub>  | Logic Output B.                                 |
| 7       | VIA              | Logic Input A.                                  |
| 8       | $V_{DD2}$        | Supply Voltage for Isolator Side 2.             |

 $<sup>^{\</sup>rm 1}$  Reference the AN-1109 Application Note for specific layout guidelines.

# TYPICAL PERFORMANCE CHARACTERISTICS

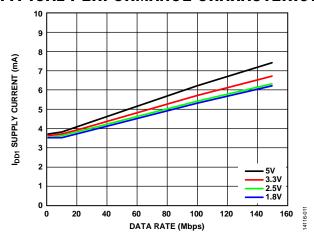


Figure 11. ADuM220N/ADuM225N I<sub>DD1</sub> Supply Current vs. Data Rate at Various Voltages

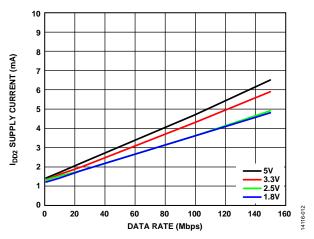


Figure 12. ADuM220N/ADuM225N I<sub>DD2</sub> Supply Current vs. Data Rate at Various Voltages

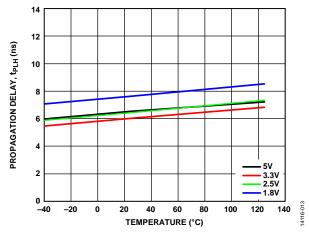


Figure 13. Propagation Delay for Logic High Output (tplh) vs. Temperature at Various Voltages

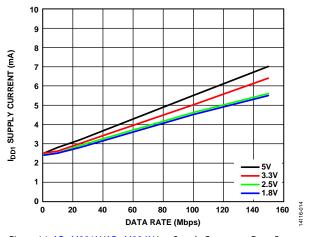


Figure 14. ADuM221N/ADuM226N I<sub>DD1</sub> Supply Current vs. Data Rate at Various Voltages

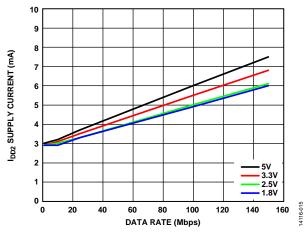


Figure 15. ADuM221N/ADuM226N I<sub>DD2</sub> Supply Current vs. Data Rate at Various Voltages

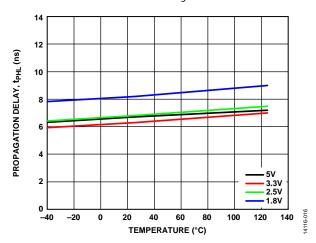


Figure 16. Propagation Delay for Logic Low Output (t<sub>PHL</sub>) vs. Temperature at Various Voltages

# THEORY OF OPERATION OVERVIEW

The ADuM220N/ADuM221N/ADuM225N/ADuM226N use a high frequency carrier to transmit data across the isolation barrier using *i*Coupler chip scale transformer coils separated by layers of polyimide isolation. Using an on/off keying (OOK) technique and the differential architecture shown in Figure 17 and Figure 18, the ADuM220N/ADuM221N/ADuM225N/ADuM226N have very low propagation delay and high speed. Internal regulators and input/output design techniques allow logic and supply voltages over a wide range from 1.7 V to 5.5 V, offering voltage translation of 1.8 V, 2.5 V, 3.3 V, and 5 V logic. The architecture is designed for high common-mode transient immunity and high immunity to electrical noise and magnetic interference. Radiated emissions are minimized with a spread spectrum OOK carrier and other techniques.

Figure 17 illustrates the waveforms for models of the ADuM220N/ADuM221N/ADuM225N/ADuM226N that have the condition of the fail-safe output state equal to low, where the carrier waveform is off when the input state is low. If the input side is off or not operating, the fail-safe output state of low (ADuM220N0/ADuM221N0/ADuM225N0/ADuM226N0 models) sets the output to low. For the ADuM220N/ADuM221N/ADuM225N/ADuM226N that have a fail-safe output state of high, Figure 18 illustrates the conditions where the carrier waveform is off when the input state is high. When the input side is off or not operating, the fail-safe output state of high (ADuM220N1/ADuM221N1/ADuM225N1/ADuM226N1) sets the output to high. See the Ordering Guide for the model numbers that have the fail-safe output state of low or the fail-safe output state of high.

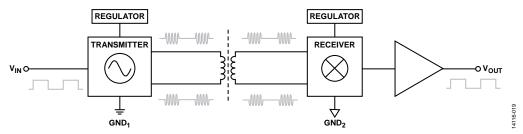


Figure 17. Operational Block Diagram of a Single Channel with a Low Fail-Safe Output State

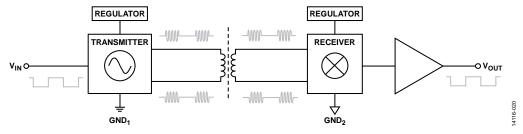


Figure 18. Operational Block Diagram of a Single Channel with a High Fail-Safe Output State

# APPLICATIONS INFORMATION PCB LAYOUT

The ADuM220N/ADuM221N/ADuM225N/ADuM226N

digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 19 and Figure 20). For the ADuM225N/ADuM226N, bypass capacitors are most conveniently connected between Pin 1 and Pin 4 for  $V_{\rm DD1}$  and between Pin 5 and Pin 8 for  $V_{\rm DD2}$ . For the ADuM220N/ADuM221N, bypass capacitors are most conveniently connected between Pin 1 and Pin 3 for  $V_{\rm DD1}$  and between Pin 14 and Pin 16 for  $V_{\rm DD2}$ . The recommended bypass capacitor value is between 0.01  $\mu F$  and 0.1  $\mu F$ . The total lead length between both ends of the capacitor and the input power supply pin must not exceed 10 mm. For the ADuM220N/ADuM221N, bypassing between Pin 3 and Pin 7 and between Pin 9 and Pin 14 must also be considered, unless the ground pair on each package side are connected close to the package.

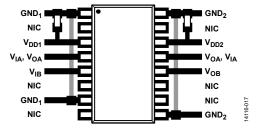


Figure 19. Recommended PCB Layout for ADuM220N/ADuM221N

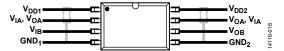


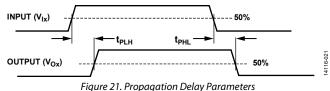
Figure 20. Recommended PCB Layout for ADuM225N/ADuM226N

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, design the board layout such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this can cause voltage differentials between pins exceeding the Absolute Maximum Ratings of the device, thereby leading to latch-up or permanent damage.

See the AN-1109 Application Note for board layout guidelines.

## PROPAGATION DELAY RELATED PARAMETERS

Propagation delay is a parameter that describes the time it takes a logic signal to propagate through a component. The propagation delay to a Logic 0 output may differ from the propagation delay to a Logic 1 output.



Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the timing of the input signal is preserved.

Channel matching is the maximum amount the propagation delay differs between channels within a single ADuM220N/ADuM221N/ADuM225N/ADuM226N component.

Propagation delay skew is the maximum amount the propagation delay differs between multiple ADuM220N/ADuM221N/ADuM225N/ADuM226N components operating under the same conditions.

#### JITTER MEASUREMENT

Figure 22 shows the eye diagram for the ADuM220N/ ADuM221N/ADuM225N/ADuM226N. The measurement was taken using an Agilent 81110A pulse pattern generator at 150 Mbps with pseudorandom bit sequences (PRBS) 2(n-1), n=14, for 5 V supplies. Jitter was measured with the Tektronix Model 5104B oscilloscope, 1 GHz, 10 GSPS with the DPOJET jitter and eye diagram analysis tools. The result shows a typical measurement on the ADuM220N/ADuM221N/ADuM225N/ ADuM226N with 380 ps p-p jitter.

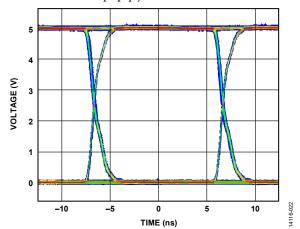


Figure 22. ADuM220N/ADuM221N/ADuM225N/ADuM226N Eye Diagram

#### **INSULATION LIFETIME**

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation as well as on the materials and material interfaces.

The two types of insulation degradation of primary interest are breakdown along surfaces exposed to the air and insulation wear out. Surface breakdown is the phenomenon of surface tracking, and the primary determinant of surface creepage requirements in system level standards. Insulation wear out is the phenomenon where charge injection or displacement currents inside the insulation material cause long-term insulation degradation.

### **Surface Tracking**

Surface tracking is addressed in electrical safety standards by setting a minimum surface creepage based on the working voltage, the environmental conditions, and the properties of the insulation material. Safety agencies perform characterization testing on the surface insulation of components that allows the components to be categorized in different material groups. Lower material group ratings are more resistant to surface tracking and, therefore, can provide adequate lifetime with smaller creepage. The minimum creepage for a given working voltage and material group is in each system level standard and is based on the total rms voltage across the isolation, pollution degree, and material group. The material group and creepage for the ADuM220N/ADuM221N/ADuM225N/ADuM226N isolators are presented in Table 9 and Table 10.

#### **Insulation Wear Out**

The lifetime of insulation caused by wear out is determined by its thickness, material properties, and the voltage stress applied. It is important to verify that the product lifetime is adequate at the application working voltage. The working voltage supported by an isolator for wear out may not be the same as the working voltage supported for tracking. It is the working voltage applicable to tracking that is specified in most standards.

Testing and modeling show that the primary driver of long-term degradation is displacement current in the polyimide insulation causing incremental damage. The stress on the insulation can be broken down into broad categories, such as dc stress, which causes very little wear out because there is no displacement current, and an ac component time varying voltage stress, which causes wear out.

The ratings in certification documents are usually based on 60 Hz sinusoidal stress because this reflects isolation from line voltage. However, many practical applications have combinations of 60 Hz ac and dc across the barrier as shown in Equation 1. Because only the ac portion of the stress causes wear out, the equation can be rearranged to solve for the ac rms voltage, as is shown in Equation 2. For insulation wear out with the polyimide materials used in these products, the ac rms voltage determines the product lifetime.

$$V_{RMS} = \sqrt{V_{AC \ RMS}^2 + V_{DC}^2} \tag{1}$$

or

$$V_{ACRMS} = \sqrt{V_{RMS}^2 - V_{DC}^2}$$
 (2)

where:

 $V_{RMS}$  is the total rms working voltage.

 $V_{AC\,RMS}$  is the time varying portion of the working voltage.  $V_{DC}$  is the dc offset of the working voltage.

### Calculation and Use of Parameters Example

The following example frequently arises in power conversion applications. Assume that the line voltage on one side of the isolation is 240 V ac rms and a 400 V dc bus voltage is present on the other side of the isolation barrier. The isolator material is polyimide. To establish the critical voltages in determining the creepage, clearance and lifetime of a device, see Table 18 and Table 19 and the following equations.

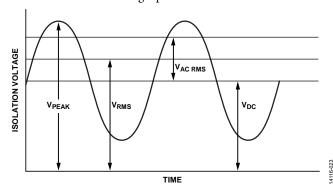


Figure 23. Critical Voltage Example

The working voltage across the barrier from Equation 1 is

$$V_{RMS} = \sqrt{{V_{AC}}_{RMS}^2 + {V_{DC}}^2}$$
 
$$V_{RMS} = \sqrt{240^2 + 400^2}$$

$$V_{RMS} = 466 \text{ V}$$

This  $V_{\text{RMS}}$  value is the working voltage used together with the material group and pollution degree when looking up the creepage required by a system standard.

To determine if the lifetime is adequate, obtain the time varying portion of the working voltage. To obtain the ac rms voltage, use Equation 2.

$$V_{AC\,RMS} = \sqrt{{V_{RMS}}^2 - {V_{DC}}^2}$$
 
$$V_{AC\,RMS} = \sqrt{466^2 - 400^2}$$

$$V_{ACRMS} = 240 \text{ V rms}$$

In this case, the ac rms voltage is simply the line voltage of  $240~\rm V$  rms. This calculation is more relevant when the waveform is not sinusoidal. The value is compared to the limits for the continuous working voltage in Table 18 and Table 19 for the expected lifetime, less than a 60 Hz sine wave, and it is well within the limit for a 50-year service life.

Note that the dc working voltage limits in Table 18 and Table 19 are set by the creepage of the package as specified in IEC 60664-1. These values can differ for specific system level standards.

# **OUTLINE DIMENSIONS**

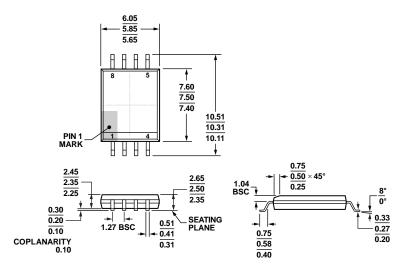
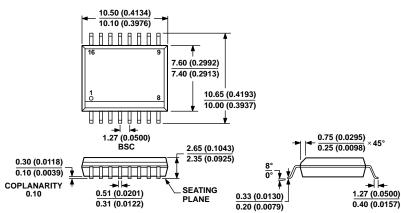


Figure 24. 8-Lead Standard Small Outline Package, with Increased Creepage [SOIC\_IC] Wide Body (RI-8-1)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MS-013-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 25. 16-Lead Standard Small Outline Package [SOIC\_W] Wide Body (RW-16)

Dimensions shown in millimeters and (inches)

### **ORDERING GUIDE**

| Model <sup>1, 2</sup> | Temperature<br>Range | No. of<br>Inputs,<br>V <sub>DD1</sub><br>Side | No. of<br>Inputs,<br>V <sub>DD2</sub><br>Side | Withstand<br>Voltage<br>Rating<br>(kV rms) | Fail-Safe<br>Output<br>State | Package<br>Description | Package<br>Option |
|-----------------------|----------------------|---|---|--|------------------------------|------------------------|-------------------|
| ADuM220N1BRWZ         | −40°C to +125°C      | 2   | 0   | 5.0  | High                         | 16-Lead SOIC_W         | RW-16             |
| ADuM220N1BRWZ-RL      | -40°C to +125°C      | 2   | 0   | 5.0  | High                         | 16-Lead SOIC_W         | RW-16             |
| ADuM220N0BRWZ         | −40°C to +125°C      | 2   | 0   | 5.0  | Low                          | 16-Lead SOIC_W         | RW-16             |
| ADuM220N0BRWZ-RL      | -40°C to +125°C      | 2   | 0   | 5.0  | Low                          | 16-Lead SOIC_W         | RW-16             |
| ADuM221N1BRWZ         | −40°C to +125°C      | 1   | 1   | 5.0  | High                         | 16-Lead SOIC_W         | RW-16             |
| ADuM221N1BRWZ-RL      | -40°C to +125°C      | 1   | 1   | 5.0  | High                         | 16-Lead SOIC_W         | RW-16             |
| ADuM221N0BRWZ         | −40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 16-Lead SOIC_W         | RW-16             |
| ADuM221N0BRWZ-RL      | -40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 16-Lead SOIC_W         | RW-16             |
| ADuM221N0WBRWZ        | −40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 16-Lead SOIC_W         | RW-16             |
| ADuM221N0WBRWZ-RL     | −40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 16-Lead SOIC_W         | RW-16             |
| ADuM225N1BRIZ         | −40°C to +125°C      | 2   | 0   | 5.0  | High                         | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM225N1BRIZ-RL      | -40°C to +125°C      | 2   | 0   | 5.0  | High                         | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM225N0BRIZ         | -40°C to +125°C      | 2   | 0   | 5.0  | Low                          | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM225N0BRIZ-RL      | -40°C to +125°C      | 2   | 0   | 5.0  | Low                          | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM226N1BRIZ         | -40°C to +125°C      | 1   | 1   | 5.0  | High                         | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM226N1BRIZ-RL      | -40°C to +125°C      | 1   | 1   | 5.0  | High                         | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM226N0BRIZ         | -40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM226N0BRIZ-RL      | -40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM226N0WBRIZ        | -40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 8-Lead SOIC_IC         | RI-8-1            |
| ADuM226N0WBRIZ-RL     | −40°C to +125°C      | 1   | 1   | 5.0  | Low                          | 8-Lead SOIC_IC         | RI-8-1            |

<sup>&</sup>lt;sup>1</sup> Z = RoHS Compliant Part.

## **AUTOMOTIVE PRODUCTS**

The ADuM221N0WBRWZ, ADuM221N0WBRWZ-RL, ADuM226N0WBRIZ, and ADuM226N0WBRIZ-RL models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

Rev. B | Page 23 of 23

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 $<sup>^{2}</sup>$  W = Qualified for Automotive Applications.